Lattice Semiconductor Corporation - LFECP15E-4FN484I Datasheet

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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

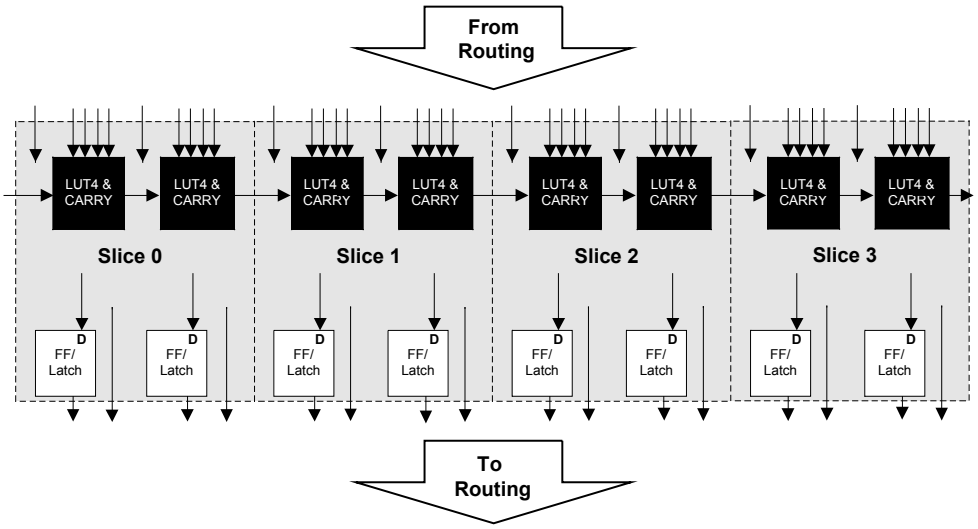
Details	
Product Status	Obsolete
Number of LABs/CLBs	-
Number of Logic Elements/Cells	15400
Total RAM Bits	358400
Number of I/O	352
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	484-BBGA
Supplier Device Package	484-FPBGA (23x23)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfecp15e-4fn484i

PFU and PFF Blocks

The core of the LatticeECP/EC devices consists of PFU and PFF blocks. The PFUs can be programmed to perform Logic, Arithmetic, Distributed RAM and Distributed ROM functions. PFF blocks can be programmed to perform Logic, Arithmetic and ROM functions. Except where necessary, the remainder of the data sheet will use the term PFU to refer to both PFU and PFF blocks.

Each PFU block consists of four interconnected slices, numbered 0-3 as shown in Figure 2-3. All the interconnections to and from PFU blocks are from routing. There are 53 inputs and 25 outputs associated with each PFU block.

Figure 2-3. PFU Diagram



Slice

Each slice contains two LUT4 lookup tables feeding two registers (programmed to be in FF or Latch mode), and some associated logic that allows the LUTs to be combined to perform functions such as LUT5, LUT6, LUT7 and LUT8. There is control logic to perform set/reset functions (programmable as synchronous/asynchronous), clock select, chip-select and wider RAM/ROM functions. Figure 2-4 shows an overview of the internal logic of the slice. The registers in the slice can be configured for positive/negative and edge/level clocks.

There are 14 input signals: 13 signals from routing and one from the carry-chain (from adjacent slice or PFU). There are 7 outputs: 6 to routing and one to carry-chain (to adjacent PFU). Table 2-1 lists the signals associated with each slice.

Table 2-7. Maximum Number of Elements in a Block

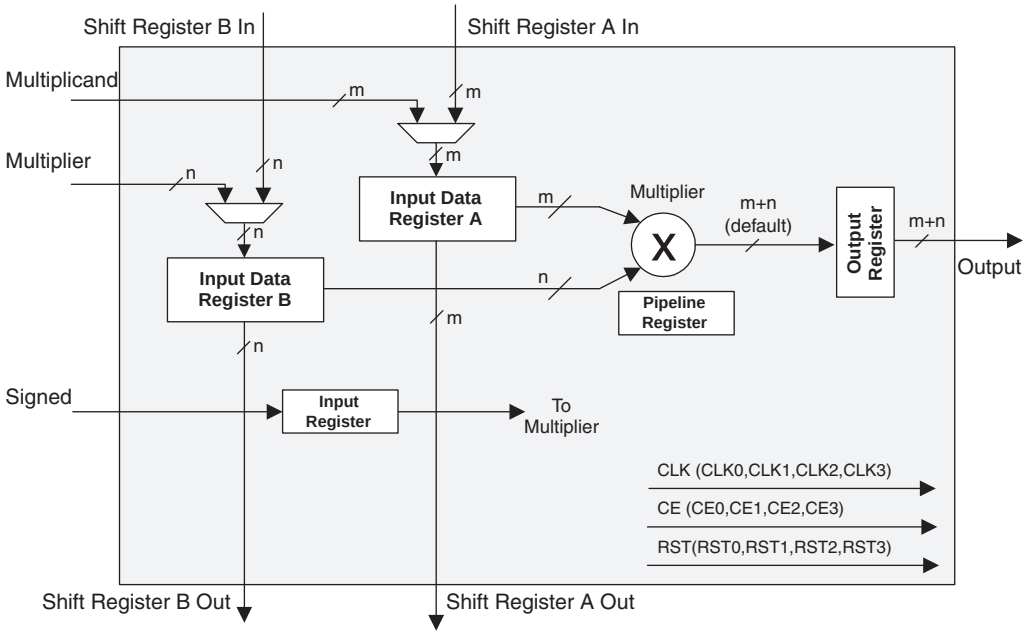
Width of Multiply	x9	x18	x36
MULT	8	4	1
MAC	2	2	—
MULTADD	4	2	—
MULTADDSUM	2	1	—

Some options are available in four elements. The input register in all the elements can be directly loaded or can be loaded as shift registers from previous operand registers. In addition by selecting “dynamic operation” in the ‘Signed/Unsigned’ options the operands can be switched between signed and unsigned on every cycle. Similarly by selecting ‘Dynamic operation’ in the ‘Add/Sub’ option the Accumulator can be switched between addition and subtraction on every cycle.

MULT sysDSP Element

This multiplier element implements a multiply with no addition or accumulator nodes. The two operands, A and B, are multiplied and the result is available at the output. The user can enable the input/output and pipeline registers. Figure 2-19 shows the MULT sysDSP element.

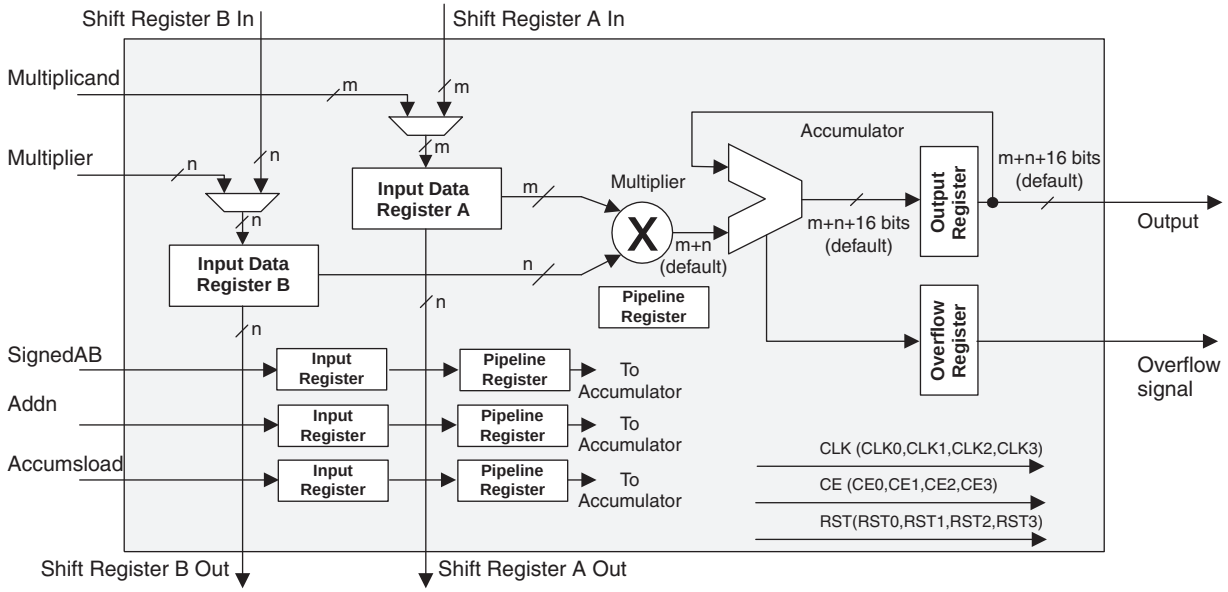
Figure 2-19. MULT sysDSP Element



MAC sysDSP Element

In this case the two operands, A and B, are multiplied and the result is added with the previous accumulated value. This accumulated value is available at the output. The user can enable the input and pipeline registers but the output register is always enabled. The output register is used to store the accumulated value. A registered overflow signal is also available. The overflow conditions are provided later in this document. Figure 2-20 shows the MAC sysDSP element.

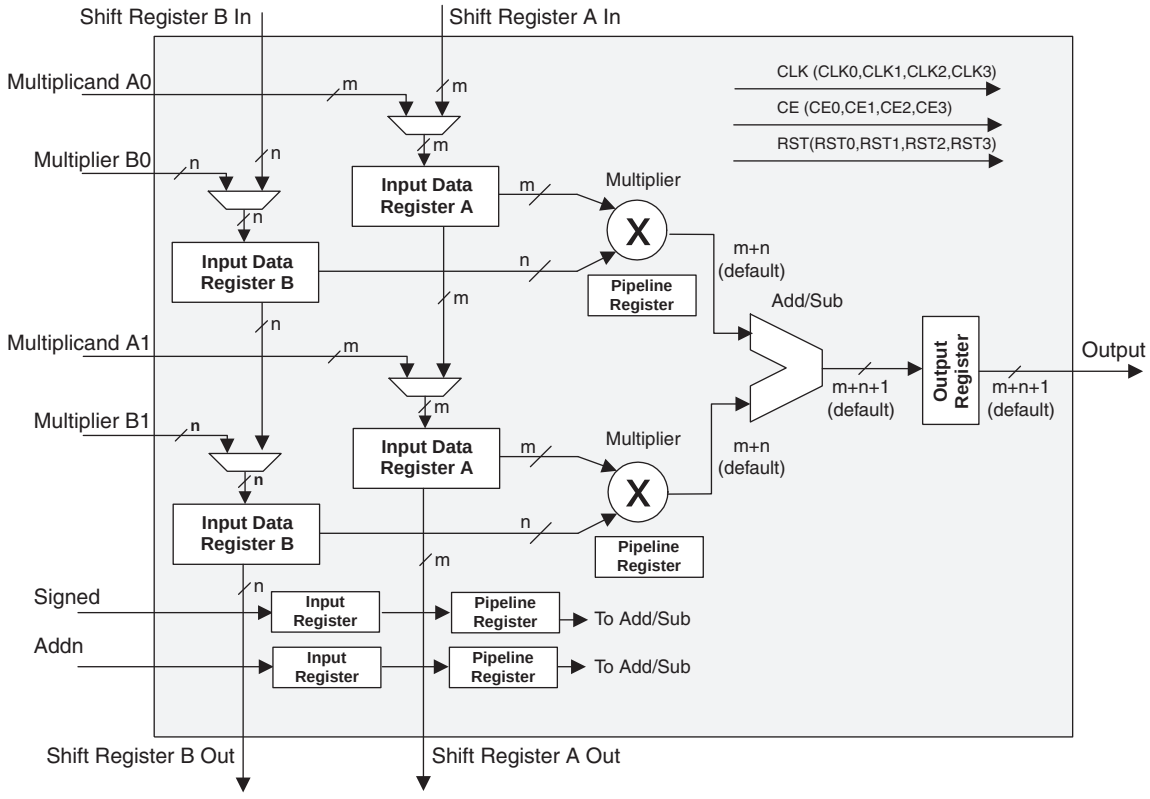
Figure 2-20. MAC sysDSP Element



MULTADD sysDSP Element

In this case, the operands A0 and B0 are multiplied and the result is added/subtracted with the result of the multiplier operation of operands A1 and A2. The user can enable the input, output and pipeline registers. Figure 2-21 shows the MULTADD sysDSP element.

Figure 2-21. MULTADD

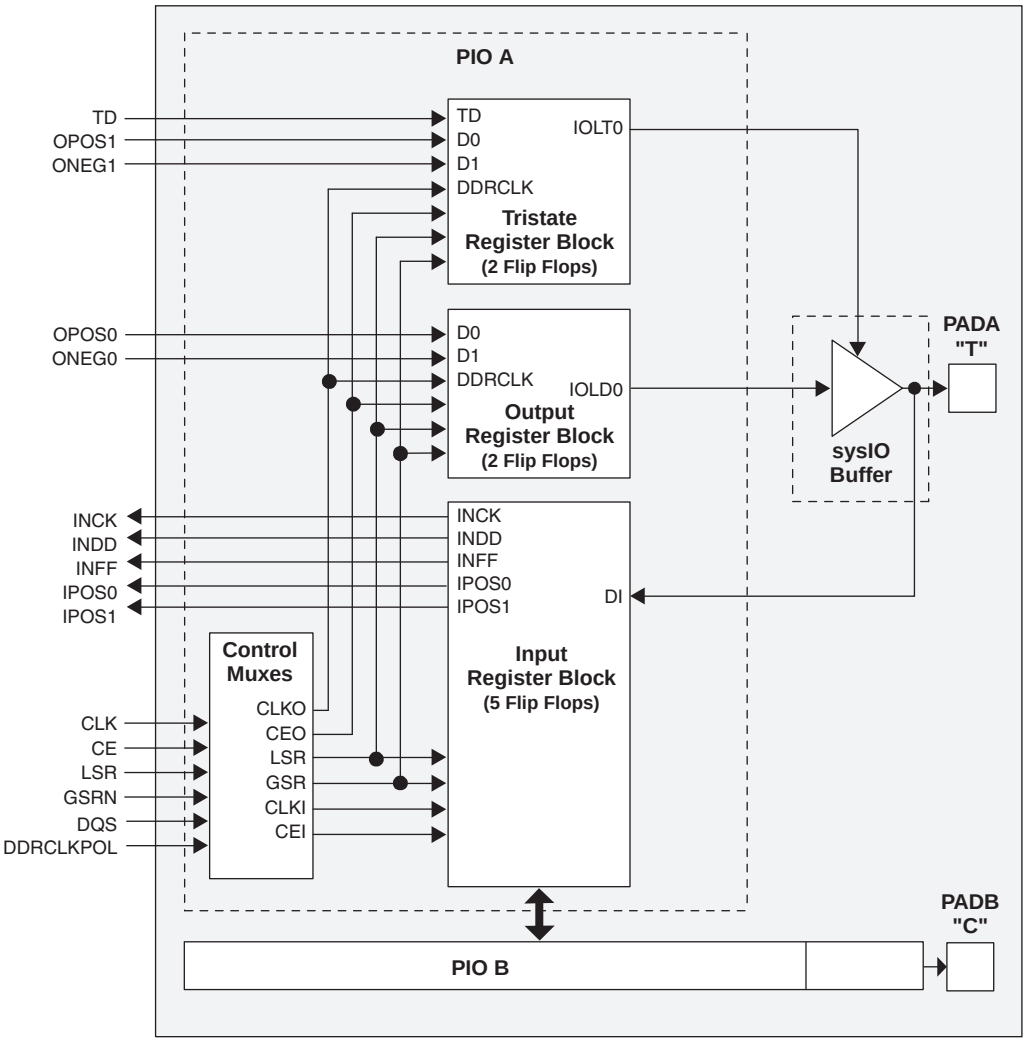


For further information about the sysDSP block, please see the list of technical information at the end of this data sheet.

Programmable I/O Cells (PIC)

Each PIC contains two PIOs connected to their respective sysI/O Buffers which are then connected to the PADs as shown in Figure 2-24. The PIO Block supplies the output data (DO) and the Tri-state control signal (TO) to sysI/O buffer, and receives input from the buffer.

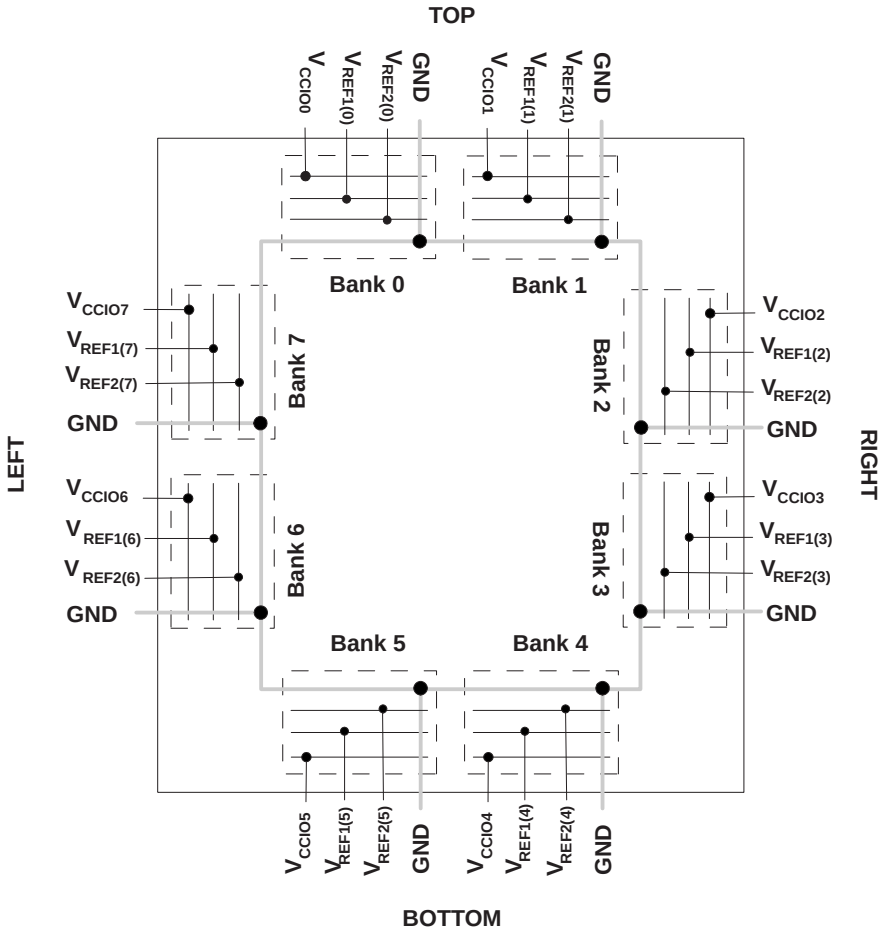
Figure 2-24. PIC Diagram



Two adjacent PIOs can be joined to provide a differential I/O pair (labeled as “T” and “C”) as shown in Figure 2-25. The PAD Labels “T” and “C” distinguish the two PIOs. Only the PIO pairs on the left and right edges of the device can be configured as LVDS transmit/receive pairs.

One of every 16 PIOs contains a delay element to facilitate the generation of DQS signals. The DQS signal feeds the DQS bus which spans the set of 16 PIOs. Figure 2-25 shows the assignment of DQS pins in each set of 16 PIOs. The exact DQS pins are shown in a dual function in the Logic Signal Connections table at the end of this data sheet. Additional detail is provided in the Signal Descriptions table at the end of this data sheet. The DQS signal from the bus is used to strobe the DDR data from the memory into input register blocks. This interface is designed for memories that support one DQS strobe per eight bits of data.

Figure 2-34. LatticeECP/EC Banks



LatticeECP/EC devices contain two types of sysI/O buffer pairs.

1. **Top and Bottom sysI/O Buffer Pairs (Single-Ended Outputs Only)**
   The sysI/O buffer pairs in the top and bottom banks of the device consist of two single-ended output drivers and two sets of single-ended input buffers (both ratioed and referenced). The referenced input buffer can also be configured as a differential input.

   The two pads in the pair are described as “true” and “comp”, where the true pad is associated with the positive side of the differential input buffer and the comp (complementary) pad is associated with the negative side of the differential input buffer.

   Only the I/Os on the top and bottom banks have programmable PCI clamps. These I/O banks also support hot socketing with IDK less than 1mA. Note that the PCI clamp is enabled after V_{CC}, V_{CCAUX} and V_{CCIO} are at valid operating levels and the device has been configured.

2. **Left and Right sysI/O Buffer Pairs (Differential and Single-Ended Outputs)**
   The sysI/O buffer pairs in the left and right banks of the device consist of two single-ended output drivers, two sets of single-ended input buffers (both ratioed and referenced) and one differential output driver. The referenced input buffer can also be configured as a differential input. In these banks the two pads in the pair are described as “true” and “comp”, where the true pad is associated with the positive side of the differential I/O, and the comp (complementary) pad is associated with the negative side of the differential I/O.

   Only the left and right banks have LVDS differential output drivers. See the I_{DK} specification for I/O leakage current during power-up.

be shifted in and loaded directly onto test nodes, or test data to be captured and shifted out for verification. The test access port consists of dedicated I/Os: TDI, TDO, TCK and TMS. The test access port has its own supply voltage V_{CCJ} and can operate with LVCMOS3.3, 2.5, 1.8, 1.5 and 1.2 standards.

For more details on boundary scan test, please see information regarding additional technical documentation at the end of this data sheet.

Device Configuration

All LatticeECP/EC devices contain two possible ports that can be used for device configuration. The test access port (TAP), which supports bit-wide configuration, and the sysCONFIG port that supports both byte-wide and serial configuration.

The TAP supports both the IEEE Std. 1149.1 Boundary Scan specification and the IEEE Std. 1532 In-System Configuration specification. The sysCONFIG port is a 20-pin interface with six of the I/Os used as dedicated pins and the rest being dual-use pins (please refer to TN1053 for more information about using the dual-use pins as general purpose I/O). There are four configuration options for LatticeECP/EC devices:

1. Industry standard SPI memories.
2. Industry standard byte wide flash and ispMACH 4000 for control/addressing.
3. Configuration from system microprocessor via the configuration bus or TAP.
4. Industry standard FPGA board memory.

On power-up, the FPGA SRAM is ready to be configured with the sysCONFIG port active. The IEEE 1149.1 serial mode can be activated any time after power-up by sending the appropriate command through the TAP port. Once a configuration port is selected, that port is locked and another configuration port cannot be activated until the next power-up sequence.

For more information about device configuration, please see the list of technical documentation at the end of this data sheet.

Internal Logic Analyzer Capability (ispTRACY)

All LatticeECP/EC devices support an internal logic analyzer diagnostic feature. The diagnostic features provide capabilities similar to an external logic analyzer, such as programmable event and trigger condition and deep trace memory. This feature is enabled by Lattice's ispTRACY. The ispTRACY utility is added into the user design at compile time.

For more information about ispTRACY, please see information regarding additional technical documentation at the end of this data sheet.

External Resistor

LatticeECP/EC devices require a single external, 10K ohm +/- 1% value between the XRES pin and ground. Device configuration will not be completed if this resistor is missing. There is no boundary scan register on the external resistor pad.

BLVDS

The LatticeECP/EC devices support BLVDS standard. This standard is emulated using complementary LVCMOS outputs in conjunction with a parallel external resistor across the driver outputs. BLVDS is intended for use when multi-drop and bi-directional multi-point differential signaling is required. The scheme shown in Figure 3-2 is one possible solution for bi-directional multi-point differential signals.

Figure 3-2. BLVDS Multi-point Output Example

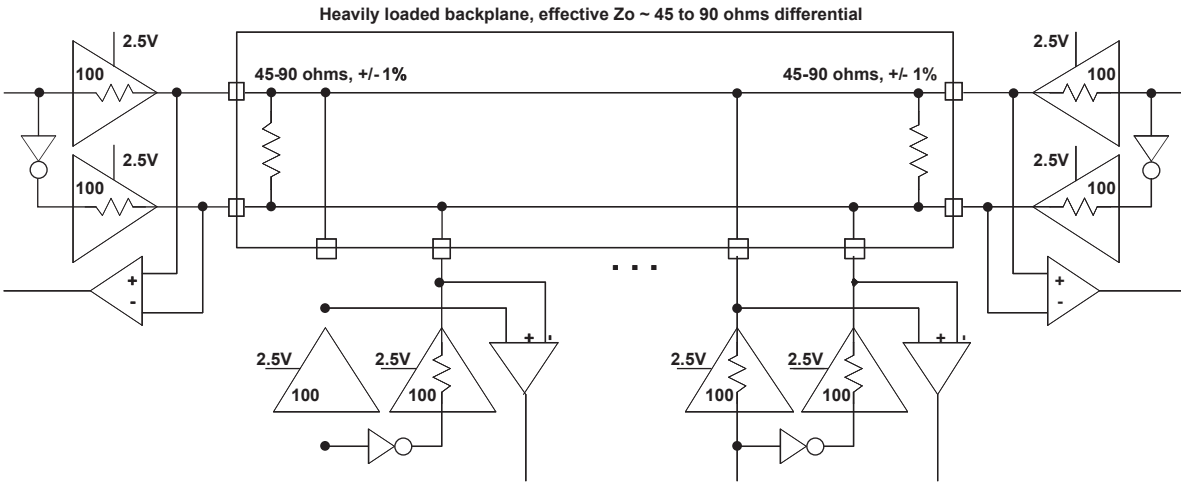


Table 3-2. BLVDS DC Conditions[1]

Over Recommended Operating Conditions

Parameter	Description	Typical		Units
		Zo = 45	Zo = 90	
Z_{OUT}	Output impedance	100	100	ohm
R_{TLEFT}	Left end termination	45	90	ohm
R_{TRIGHT}	Right end termination	45	90	ohm
V_{OH}	Output high voltage	1.375	1.48	V
V_{OL}	Output low voltage	1.125	1.02	V
V_{OD}	Output differential voltage	0.25	0.46	V
V_{CM}	Output common mode voltage	1.25	1.25	V
I_{DC}	DC output current	11.2	10.2	mA

1. For input buffer, see LVDS table.

LVPECL

The LatticeECP/EC devices support differential LVPECL standard. This standard is emulated using complementary LVCMOS outputs in conjunction with a parallel resistor across the driver outputs. The LVPECL input standard is supported by the LVDS differential input buffer. The scheme shown in Figure 3-3 is one possible solution for point-to-point signals.

Figure 3-3. Differential LVPECL

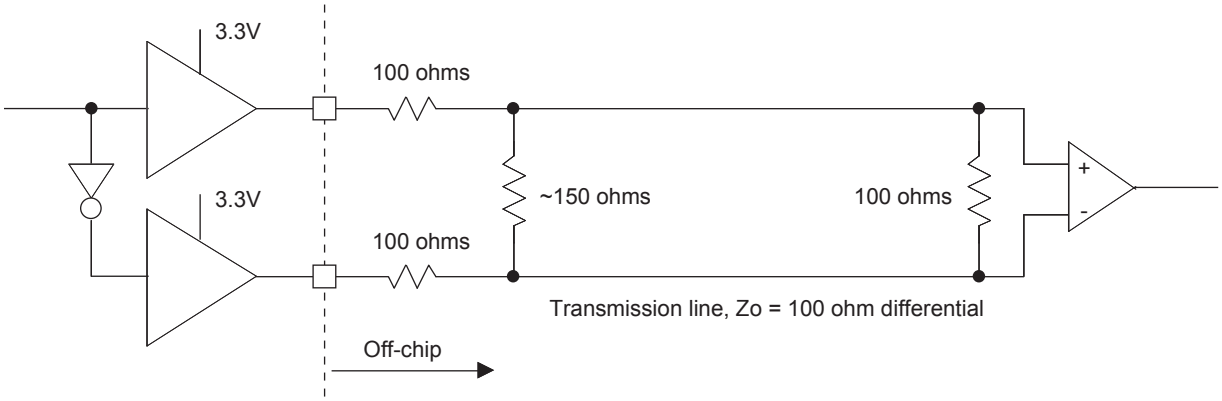


Table 3-3. LVPECL DC Conditions[1]

Over Recommended Operating Conditions

Parameter	Description	Typical	Units
Z_{OUT}	Output impedance	100	ohm
R_P	Driver parallel resistor	150	ohm
R_T	Receiver termination	100	ohm
V_{OH}	Output high voltage	2.03	V
V_{OL}	Output low voltage	1.27	V
V_{OD}	Output differential voltage	0.76	V
V_{CM}	Output common mode voltage	1.65	V
Z_{BACK}	Back impedance	85.7	ohm
I_{DC}	DC output current	12.7	mA

1. For input buffer, see LVDS table.

For further information about LVPECL, BLVDS and other differential interfaces please see the list of technical information at the end of this data sheet.

LatticeECP/EC External Switching Characteristics

Over Recommended Operating Conditions

Parameter	Description	Device	-5		-4		-3		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
General I/O Pin Parameters (Using Primary Clock without PLL)[1]									
t_{CO}[7]	Clock to Output - PIO Output Register	LFEC1	—	5.09	—	6.11	—	7.13	ns
		LFEC3	—	5.71	—	6.85	—	7.99	ns
		LFEC6	—	5.60	—	6.72	—	7.84	ns
		LFEC10	—	5.47	—	6.57	—	7.66	ns
		LFEC15	—	5.67	—	6.81	—	7.94	ns
		LFEC20	—	5.89	—	7.07	—	8.25	ns
		LFEC33	—	6.19	—	7.42	—	8.66	ns
t_{SU}[7]	Clock to Data Setup - PIO Input Register	LFEC1	-0.08	—	-0.10	—	-0.12	—	ns
		LFEC3	-0.70	—	-0.84	—	-0.98	—	ns
		LFEC6	-0.63	—	-0.76	—	-0.89	—	ns
		LFEC10	-0.43	—	-0.52	—	-0.61	—	ns
		LFEC15	-0.70	—	-0.84	—	-0.98	—	ns
		LFEC20	-0.88	—	-1.06	—	-1.24	—	ns
		LFEC33	-1.12	—	-1.34	—	-1.56	—	ns
t_{H}[7]	Clock to Data Hold - PIO Input Register	LFEC1	2.19	—	2.62	—	3.06	—	ns
		LFEC3	2.80	—	3.36	—	3.92	—	ns
		LFEC6	2.69	—	3.23	—	3.77	—	ns
		LFEC10	2.56	—	3.08	—	3.59	—	ns
		LFEC15	2.76	—	3.32	—	3.87	—	ns
		LFEC20	2.99	—	3.58	—	4.18	—	ns
		LFEC33	3.28	—	3.93	—	4.59	—	ns
t_{SU_DEL}[7]	Clock to Data Setup - PIO Input Register with Data Input Delay	LFEC1	3.36	—	4.03	—	4.70	—	ns
		LFEC3	2.74	—	3.29	—	3.84	—	ns
		LFEC6	2.81	—	3.37	—	3.93	—	ns
		LFEC10	3.01	—	3.61	—	4.21	—	ns
		LFEC15	2.74	—	3.29	—	3.83	—	ns
		LFEC20	2.56	—	3.07	—	3.58	—	ns
		LFEC33	2.32	—	2.79	—	3.25	—	ns
t_{H_DEL}[7]	Clock to Data Hold - PIO Input Register with Input Data Delay	LFEC1	-1.31	—	-1.57	—	-1.83	—	ns
		LFEC3	-0.70	—	-0.83	—	-0.97	—	ns
		LFEC6	-0.80	—	-0.96	—	-1.12	—	ns
		LFEC10	-0.93	—	-1.12	—	-1.30	—	ns
		LFEC15	-0.73	—	-0.88	—	-1.02	—	ns
		LFEC20	-0.51	—	-0.61	—	-0.71	—	ns
		LFEC33	-0.22	—	-0.26	—	-0.30	—	ns
f_{MAX_IO}[2]	Clock Frequency of I/O and PFU Register	All	—	420	—	378	—	340	Mhz
DDR I/O Pin Parameters[3, 4, 5]									
t_{DVADQ}	Data Valid After DQS (DDR Read)	All	—	0.19	—	0.19	—	0.19	UI
t_{DVEDQ}	Data Hold After DQS (DDR Read)	All	0.67	—	0.67	—	0.67	—	UI

LatticeECP/EC Internal Switching Characteristics (Continued)

Over Recommended Operating Conditions

Parameter	Description	-5		-4		-3		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
t_{SUCE_EBR}	Clock Enable Setup Time to EBR Output Register	0.18	—	0.21	—	0.25	—	ns
t_{HCE_EBR}	Clock Enable Hold Time to EBR Output Register	-0.14	—	-0.17	—	-0.20	—	ns
t_{RSTO_EBR}	Reset To Output Delay Time from EBR Output Register	—	1.47	—	1.76	—	2.05	ns
PLL Parameters								
t_{RSTREC}	Reset Recovery to Rising Clock	1.00	—	1.00	—	1.00	—	ns
t_{RSTSU}	Reset Signal Setup Time	1.00	—	1.00	—	1.00	—	ns
DSP Block Timing[2, 3]								
t_{SUI_DSP}	Input Register Setup Time	-0.38	—	-0.30	—	-0.23	—	ns
t_{HI_DSP}	Input Register Hold Time	0.71	—	0.86	—	1.00	—	ns
t_{SUP_DSP}	Pipeline Register Setup Time	3.31	—	3.98	—	4.64	—	ns
t_{HP_DSP}	Pipeline Register Hold Time	0.71	—	0.86	—	1.00	—	ns
t_{SUO_DSP}[4]	Output Register Setup Time	5.54	—	6.64	—	7.75	—	ns
t_{HO_DSP}[4]	Output Register Hold Time	0.71	—	0.86	—	1.00	—	ns
t_{COI_DSP}[4]	Input Register Clock to Output Time	—	7.50	—	9.00	—	10.50	ns
t_{COP_DSP}[4]	Pipeline Register Clock to Output Time	—	4.66	—	5.60	—	6.53	ns
t_{COO_DSP}	Output Register Clock to Output Time	—	1.47	—	1.77	—	2.06	ns
$t_{SUADSUB}$	AdSub Input Register Setup Time	-0.38	—	-0.30	—	-0.23	—	ns
t_{HADSUB}	AdSub Input Register Hold Time	0.71	—	0.86	—	1.00	—	ns

1. Internal parameters are characterized but not tested on every device.
2. These parameters apply to LatticeECP devices only.
3. DSP Block is configured in Multiply Add/Sub 18 x 18 Mode.
4. These parameters include the Adder Subtractor block in the path.

Timing v.G 0.30

Pin Information Summary (Cont.)

Pin Type		LFECP/EC15		LFECP20/EC20		LFECP/EC33	
		256-fpBGA	484-fpBGA	484-fpBGA	672-fpBGA	484-fpBGA	672-fpBGA
Single Ended User I/O		195	352	360	400	360	496
Differential Pair User I/O		97	176	180	200	180	248
Configuration	Dedicated	13	13	13	13	13	13
	Muxed	56	56	56	56	56	56
TAP		5	5	5	5	5	5
Dedicated (total without supplies)		208	373	373	509	373	509
V_{CC}		10	20	20	32	16	28
V_{CCAUX}		2	12	12	20	12	20
V_{CCPLL}		0	0	0	0	4	4
V_{CCIO}	Bank0	2	4	4	6	4	6
	Bank1	2	4	4	6	4	6
	Bank2	2	4	4	6	4	6
	Bank3	2	4	4	6	4	6
	Bank4	2	4	4	6	4	6
	Bank5	2	4	4	6	4	6
	Bank6	2	4	4	6	4	6
	Bank7	2	4	4	6	4	6
GND, GND0-GND7		20	44	44	63	44	63
NC		0	11	3	96	3	0
Single Ended/ Differential I/O Pair per Bank	Bank0	32/16	48/24	48/24	64/32	48/24	64/32
	Bank1	18/9	48/24	48/24	48/24	48/24	64/32
	Bank2	16/8	40/20	40/20	40/20	40/20	56/28
	Bank3	32/16	40/20	44/22	48/24	44/22	64/32
	Bank4	17/8	48/24	48/24	48/24	48/24	64/32
	Bank5	32/16	48/24	48/24	64/32	48/24	64/32
	Bank6	32/16	40/20	44/22	48/24	44/22	64/32
	Bank7	16/8	40/20	40/20	40/20	40/20	56/28
V_{CCJ}		1	1	1	1	1	1

Note: During configuration the user-programmable I/Os are tri-stated with an internal pull-up resistor enabled. If any pin is not used (or not bonded to a package pin), it is also tri-stated with an internal pull-up resistor enabled after configuration.

LFEC1, LFEC3, LFECP/EC6 Logic Signal Connections: 144 TQFP

Pin Number	LFEC1				LFEC3				LFECP6/EC6			
	Pin Function	Bank	LVDS	Dual Function	Pin Function	Bank	LVDS	Dual Function	Pin Function	Bank	LVDS	Dual Function
1	VCCIO7	7			VCCIO7	7			VCCIO7	7		
2	PL2A	7	T	VREF2_7	PL2A	7	T	VREF2_7	PL2A	7	T	VREF2_7
3	PL2B	7	C	VREF1_7	PL2B	7	C	VREF1_7	PL2B	7	C	VREF1_7
4	PL3A	7	T		PL7A	7	T		PL7A	7	T	
5	PL3B	7	C		PL7B	7	C		PL7B	7	C	
6	PL4A	7	T		PL8A	7	T		PL8A	7	T	
7	PL4B	7	C		PL8B	7	C		PL8B	7	C	
8	PL5A	7	T	PCLKT7_0	PL9A	7	T	PCLKT7_0	PL9A	7	T	PCLKT7_0
9	PL5B	7	C	PCLKC7_0	PL9B	7	C	PCLKC7_0	PL9B	7	C	PCLKC7_0
10	XRES	6			XRES	6			XRES	6		
11	NC	-			NC	-			VCC	-		
12	NC	-			NC	-			GND	-		
13	VCC	-			VCC	-			VCC	-		
14	TCK	6			TCK	6			TCK	6		
15	GND	-			GND	-			GND	-		
16	TDI	6			TDI	6			TDI	6		
17	TMS	6			TMS	6			TMS	6		
18	TDO	6			TDO	6			TDO	6		
19	VCCJ	6			VCCJ	6			VCCJ	6		
20	PL7A	6	T	LLM0_PLLT_IN_A	PL11A	6	T	LLM0_PLLT_IN_A	PL20A	6	T	LLM0_PLLT_IN_A
21	PL7B	6	C	LLM0_PLLC_IN_A	PL11B	6	C	LLM0_PLLC_IN_A	PL20B	6	C	LLM0_PLLC_IN_A
22	PL8A	6	T	LLM0_PLLT_FB_A	PL12A	6	T	LLM0_PLLT_FB_A	PL21A	6	T	LLM0_PLLT_FB_A
23	PL8B	6	C	LLM0_PLLC_FB_A	PL12B	6	C	LLM0_PLLC_FB_A	PL21B	6	C	LLM0_PLLC_FB_A
24	VCCIO6	6			VCCIO6	6			VCCIO6	6		
25	PL9A	6	T		PL13A	6	T		PL22A	6	T	
26	PL9B	6	C		PL13B	6	C		PL22B	6	C	
27	PL10A	6	T		PL14A	6	T		PL23A	6	T	
28	GND6	6			GND6	6			GND6	6		
29	PL10B	6	C		PL14B	6	C		PL23B	6	C	
30	PL11A	6	T	LDQS11	PL15A	6	T	LDQS15	PL24A	6	T	LDQS24
31	PL11B	6	C		PL15B	6	C		PL24B	6	C	
32	PL12A	6	T		PL16A	6	T		PL25A	6	T	
33	PL12B	6	C		PL16B	6	C		PL25B	6	C	
34	PL14A	6	T	VREF1_6	PL18A	6	T	VREF1_6	PL27A	6	T	VREF1_6
35	PL14B	6	C	VREF2_6	PL18B	6	C	VREF2_6	PL27B	6	C	VREF2_6
36	VCCIO6	6			VCCIO6	6			VCCIO6	6		
37*	GND5 GND6	-			GND5 GND6	-			GND5 GND6	-		
38	VCCIO5	5			VCCIO5	5			VCCIO5	5		
39	PB2A	5	T		PB10A	5	T		PB10A	5	T	
40	PB2B	5	C		PB10B	5	C		PB10B	5	C	
41	PB3A	5	T		PB11A	5	T		PB11A	5	T	
42	PB3B	5	C		PB11B	5	C		PB11B	5	C	
43	PB5B	5			PB13B	5			PB13B	5		
44	VCCIO5	5			VCCIO5	5			VCCIO5	5		
45	PB6A	5	T	BDQS6	PB14A	5	T	BDQS14	PB14A	5	T	BDQS14
46	PB6B	5	C		PB14B	5	C		PB14B	5	C	
47	PB7A	5	T		PB15A	5	T		PB15A	5	T	
48	PB7B	5	C		PB15B	5	C		PB15B	5	C	
49	PB8A	5	T	VREF2_5	PB16A	5	T	VREF2_5	PB16A	5	T	VREF2_5

LFEC1, LFEC3 Logic Signal Connections: 208 PQFP

Pin Number	LFEC1				LFEC3			
	Pin Function	Bank	LVDS	Dual Function	Pin Function	Bank	LVDS	Dual Function
1*	GND0 GND7	-			GND0 GND7	-		
2	VCCIO7	7			VCCIO7	7		
3	PL2A	7	T	VREF2_7	PL2A	7	T	VREF2_7
4	PL2B	7	C	VREF1_7	PL2B	7	C	VREF1_7
5	NC	-			NC	-		
6	NC	-			NC	-		
7	NC	-			PL3B	7		
8	NC	-			PL4A	7	T	
9	NC	-			PL4B	7	C	
10	NC	-			PL5A	7	T	
11	NC	-			PL5B	7	C	
12	NC	-			PL6A	7	T	LDQS6
13	NC	-			VCCIO7	7		
14	NC	-			PL6B	7	C	
15	PL3A	7	T		PL7A	7	T	
16	PL3B	7	C		PL7B	7	C	
17	PL4A	7	T		PL8A	7	T	
18	NC	-			NC	-		
19	PL4B	7	C		PL8B	7	C	
20	PL5A	7	T	PCLKT7_0	PL9A	7	T	PCLKT7_0
21	PL5B	7	C	PCLKC7_0	PL9B	7	C	PCLKC7_0
22	NC	-			VCCAUX	-		
23	XRES	6			XRES	6		
24	NC	-			NC	-		
25	NC	-			NC	-		
26	VCC	-			VCC	-		
27	TCK	6			TCK	6		
28	GND	-			GND	-		
29	TDI	6			TDI	6		
30	TMS	6			TMS	6		
31	TDO	6			TDO	6		
32	VCCJ	6			VCCJ	6		
33	PL7A	6	T	LLM0_PLLT_IN_A	PL11A	6	T	LLM0_PLLT_IN_A
34	PL7B	6	C	LLM0_PLLC_IN_A	PL11B	6	C	LLM0_PLLC_IN_A
35	PL8A	6	T	LLM0_PLLT_FB_A	PL12A	6	T	LLM0_PLLT_FB_A
36	PL8B	6	C	LLM0_PLLC_FB_A	PL12B	6	C	LLM0_PLLC_FB_A
37	VCCIO6	6			VCCIO6	6		
38	PL9A	6	T		PL13A	6	T	
39	PL9B	6	C		PL13B	6	C	
40	PL10A	6	T		PL14A	6	T	
41	GND6	6			GND6	6		
42	PL10B	6	C		PL14B	6	C	

LFECP/EC10 and LFECP/EC15 Logic Signal Connections: 256 fpBGA (Cont.)

Ball Number	LFECP10/LFEC10				LFECP15/LFEC15			
	Ball Function	Bank	LVDS	Dual Function	Ball Function	Bank	LVDS	Dual Function
G9	GND	-			GND	-		
H10	GND	-			GND	-		
H7	GND	-			GND	-		
H8	GND	-			GND	-		
H9	GND	-			GND	-		
J10	GND	-			GND	-		
J7	GND	-			GND	-		
J8	GND	-			GND	-		
J9	GND	-			GND	-		
K10	GND	-			GND	-		
K7	GND	-			GND	-		
K8	GND	-			GND	-		
K9	GND	-			GND	-		
T1	GND	-			GND	-		
T16	GND	-			GND	-		
E12	VCC	-			VCC	-		
E5	VCC	-			VCC	-		
E8	VCC	-			VCC	-		
M12	VCC	-			VCC	-		
M5	VCC	-			VCC	-		
M9	VCC	-			VCC	-		
B15	VCCAUX	-			VCCAUX	-		
R2	VCCAUX	-			VCCAUX	-		
F7	VCCIO0	0			VCCIO0	0		
F8	VCCIO0	0			VCCIO0	0		
F10	VCCIO1	1			VCCIO1	1		
F9	VCCIO1	1			VCCIO1	1		
G11	VCCIO2	2			VCCIO2	2		
H11	VCCIO2	2			VCCIO2	2		
J11	VCCIO3	3			VCCIO3	3		
K11	VCCIO3	3			VCCIO3	3		
L10	VCCIO4	4			VCCIO4	4		
L9	VCCIO4	4			VCCIO4	4		
L7	VCCIO5	5			VCCIO5	5		
L8	VCCIO5	5			VCCIO5	5		
J6	VCCIO6	6			VCCIO6	6		
K6	VCCIO6	6			VCCIO6	6		
G6	VCCIO7	7			VCCIO7	7		
H6	VCCIO7	7			VCCIO7	7		
F6	VCC	-			VCC	-		
F11	VCC	-			VCC	-		
L11	VCC	-			VCC	-		
L6	VCC	-			VCC	-		

LFECP/EC6, LFECP/EC10, LFECP/EC15 Logic Signal Connections: 484 fpBGA

LFECP6/LFEC6					LFECP10/LFEC10					LFECP/LFEC15				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
GND	GND7	7			GND	GND7	7			GND	GND7	7		
D4	PL2A	7	T	VREF2_7	D4	PL2A	7	T	VREF2_7	D4	PL2A	7	T	VREF2_7
E4	PL2B	7	C	VREF1_7	E4	PL2B	7	C	VREF1_7	E4	PL2B	7	C	VREF1_7
C3	NC	-			C3	PL3A	7	T		C3	PL3A	7	T	
B2	NC	-			B2	PL3B	7	C		B2	PL3B	7	C	
E5	NC	-			E5	PL4A	7	T		E5	PL4A	7	T	
F5	NC	-			F5	PL4B	7	C		F5	PL4B	7	C	
D3	NC	-			D3	PL5A	7	T		D3	PL5A	7	T	
C2	NC	-			C2	PL5B	7	C		C2	PL5B	7	C	
F4	NC	-			F4	PL6A	7	T	LDQS6	F4	PL6A	7	T	LDQS6
G4	NC	-			G4	PL6B	7	C		G4	PL6B	7	C	
E3	NC	-			E3	PL7A	7	T		E3	PL7A	7	T	
D2	NC	-			D2	PL7B	7	C		D2	PL7B	7	C	
B1	NC	-			B1	PL8A	7	T	LUM0_PLLT_IN_A	B1	PL8A	7	T	LUM0_PLLT_IN_A
C1	NC	-			C1	PL8B	7	C	LUM0_PLLC_IN_A	C1	PL8B	7	C	LUM0_PLLC_IN_A
F3	NC	-			F3	PL9A	7	T	LUM0_PLLT_FB_A	F3	PL9A	7	T	LUM0_PLLT_FB_A
GND	-	-			GND	GND7	7			GND	GND7	7		
E2	NC	-			E2	PL9B	7	C	LUM0_PLLC_FB_A	E2	PL9B	7	C	LUM0_PLLC_FB_A
G5	NC	-			G5	NC	-			G5	PL11A	7	T	
H6	NC	-			H6	NC	-			H6	PL11B	7	C	
G3	NC	-			G3	NC	-			G3	PL12A	7	T	
H4	NC	-			H4	NC	-			H4	PL12B	7	C	
J5	NC	-			J5	NC	-			J5	PL13A	7	T	
H5	NC	-			H5	NC	-			H5	PL13B	7	C	
F2	NC	-			F2	NC	-			F2	PL14A	7	T	
GND	-	-			GND	-	-			GND	GND7	7		
F1	NC	-			F1	NC	-			F1	PL14B	7	C	
E1	NC	-			E1	PL11A	7	T		E1	PL15A	7	T	
D1	NC	-			D1	PL11B	7	C		D1	PL15B	7	C	
H3	PL3A	7	T		H3	PL12A	7	T		H3	PL16A	7	T	
G2	PL3B	7	C		G2	PL12B	7	C		G2	PL16B	7	C	
H2	PL4A	7	T		H2	PL13A	7	T		H2	PL17A	7	T	
G1	PL4B	7	C		G1	PL13B	7	C		G1	PL17B	7	C	
J4	PL5A	7	T		J4	PL14A	7	T		J4	PL18A	7	T	
GND	-	-			GND	GND7	7			GND	GND7	7		
J3	PL5B	7	C		J3	PL14B	7	C		J3	PL18B	7	C	
J2	PL6A	7	T	LDQS6	J2	PL15A	7	T	LDQS15	J2	PL19A	7	T	LDQS19
H1	PL6B	7	C		H1	PL15B	7	C		H1	PL19B	7	C	
K4	PL7A	7	T		K4	PL16A	7	T		K4	PL20A	7	T	
K5	PL7B	7	C		K5	PL16B	7	C		K5	PL20B	7	C	
K3	PL8A	7	T		K3	PL17A	7	T		K3	PL21A	7	T	
K2	PL8B	7	C		K2	PL17B	7	C		K2	PL21B	7	C	
J1	PL9A	7	T	PCLKT7_0	J1	PL18A	7	T	PCLKT7_0	J1	PL22A	7	T	PCLKT7_0
GND	GND7	7			GND	GND7	7			GND	GND7	7		
K1	PL9B	7	C	PCLKC7_0	K1	PL18B	7	C	PCLKC7_0	K1	PL22B	7	C	PCLKC7_0
L3	XRES	6			L3	XRES	6			L3	XRES	6		
L4	PL11A	6	T		L4	PL20A	6	T		L4	PL24A	6	T	
L5	PL11B	6	C		L5	PL20B	6	C		L5	PL24B	6	C	
L2	PL12A	6	T		L2	PL21A	6	T		L2	PL25A	6	T	
L1	PL12B	6	C		L1	PL21B	6	C		L1	PL25B	6	C	

LFECP/EC20 and LFECP/EC33 Logic Signal Connections: 484 fpBGA (Cont.)

LFECP20/LFEC20					LFECP/LFEC33				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
C22	PR9A	2	T	RUM0_PLLT_FB_A	C22	PR17A	2	T	RUM0_PLLT_FB_A
G19	PR8B	2	C	RUM0_PLLC_IN_A	G19	PR16B	2	C	RUM0_PLLC_IN_A
G18	PR8A	2	T	RUM0_PLLT_IN_A	G18	PR16A	2	T	RUM0_PLLT_IN_A
F20	PR7B	2	C		F20	PR15B	2	C	
F19	PR7A	2	T		F19	PR15A	2	T	
E20	PR6B	2	C		E20	PR14B	2	C	
D20	PR6A	2	T	RDQS6	D20	PR14A	2	T	RDQS14
C21	PR5B	2	C		C21	PR13B	2	C	
GND	-	-			GND	GND2	2		
C20	PR5A	2	T		C20	PR13A	2	T	
F18	PR4B	2	C		F18	PR12B	2	C	
E18	PR4A	2	T		E18	PR12A	2	T	
B22	PR3B	2	C		B22	PR11B	2	C	
B21	PR3A	2	T		B21	PR11A	2	T	
GND	-	-			GND	GND2	2		
E19	PR2B	2	C	VREF1_2	E19	PR2B	2	C	VREF1_2
D19	PR2A	2	T	VREF2_2	D19	PR2A	2	T	VREF2_2
GND	GND2	2			GND	GND2	2		
GND	GND1	1			GND	GND1	1		
GND	-	-			GND	GND1	1		
G17	PT57B	1	C		G17	PT57B	1	C	
GND	-	-			GND	GND1	1		
F17	PT57A	1	T		F17	PT57A	1	T	
D18	PT56B	1	C		D18	PT56B	1	C	
C18	PT56A	1	T		C18	PT56A	1	T	
C19	PT55B	1	C		C19	PT55B	1	C	
B20	PT55A	1	T		B20	PT55A	1	T	
D17	PT54B	1	C		D17	PT54B	1	C	
C16	PT54A	1	T	TDQS54	C16	PT54A	1	T	TDQS54
B19	PT53B	1	C		B19	PT53B	1	C	
GND	GND1	1			GND	GND1	1		
A20	PT53A	1	T		A20	PT53A	1	T	
E17	PT52B	1	C		E17	PT52B	1	C	
C17	PT52A	1	T		C17	PT52A	1	T	
F16	PT51B	1	C		F16	PT51B	1	C	
E16	PT51A	1	T		E16	PT51A	1	T	
F15	PT50B	1	C		F15	PT50B	1	C	
D16	PT50A	1	T		D16	PT50A	1	T	
B18	PT49B	1	C		B18	PT49B	1	C	
GND	GND1	1			GND	GND1	1		
A19	PT49A	1	T		A19	PT49A	1	T	
B17	PT48B	1	C		B17	PT48B	1	C	
A18	PT48A	1	T		A18	PT48A	1	T	
B16	PT47B	1	C		B16	PT47B	1	C	

LFECP/EC20, LFECP/EC33 Logic Signal Connections: 672 fpBGA (Cont.)

LFEC20/LFECP20					LFECP/EC33				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
K6	PL13B	7	C		K6	PL25B	7	C	
F1	PL14A	7	T		F1	PL26A	7	T	
GND	GND7	7			GND	GND7	7		
G1	PL14B	7	C		G1	PL26B	7	C	
H1	PL15A	7	T		H1	PL27A	7	T	
J1	PL15B	7	C		J1	PL27B	7	C	
K2	PL16A	7	T		K2	PL28A	7	T	
K1	PL16B	7	C		K1	PL28B	7	C	
K3	PL17A	7	T		K3	PL29A	7	T	
L3	PL17B	7	C		L3	PL29B	7	C	
L2	PL18A	7	T		L2	PL30A	7	T	
GND	GND7	7			GND	GND7	7		
L1	PL18B	7	C		L1	PL30B	7	C	
M3	PL19A	7	T	LDQS19	M3	PL31A	7	T	LDQS31
M4	PL19B	7	C		M4	PL31B	7	C	
M1	PL20A	7	T		M1	PL32A	7	T	
M2	PL20B	7	C		M2	PL32B	7	C	
L4	PL21A	7	T		L4	PL33A	7	T	
L5	PL21B	7	C		L5	PL33B	7	C	
N2	PL22A	7	T	PCLKT7_0	N2	PL34A	7	T	PCLKT7_0
GND	GND7	7			GND	GND7	7		
N1	PL22B	7	C	PCLKC7_0	N1	PL34B	7	C	PCLKC7_0
N3	XRES	6			N3	XRES	6		
P1	PL24A	6	T		P1	PL36A	6	T	
P2	PL24B	6	C		P2	PL36B	6	C	
L7	PL25A	6	T		L7	PL37A	6	T	
L6	PL25B	6	C		L6	PL37B	6	C	
N4	PL26A	6	T		N4	PL38A	6	T	
N5	PL26B	6	C		N5	PL38B	6	C	
R1	PL27A	6	T		R1	PL39A	6	T	
GND	GND6	6			GND	GND6	6		
R2	PL27B	6	C		R2	PL39B	6	C	
P4	PL28A	6	T	LDQS28	P4	PL40A	6	T	LDQS40
P3	PL28B	6	C		P3	PL40B	6	C	
M5	PL29A	6	T		M5	PL41A	6	T	
M6	PL29B	6	C		M6	PL41B	6	C	
T1	PL30A	6	T		T1	PL42A	6	T	
T2	PL30B	6	C		T2	PL42B	6	C	
R4	PL31A	6	T		R4	PL43A	6	T	
GND	GND6	6			GND	GND6	6		
R3	PL31B	6	C		R3	PL43B	6	C	
N6	PL32A	6	T		N6	PL44A	6	T	

LFECP/EC20, LFECP/EC33 Logic Signal Connections: 672 fpBGA (Cont.)

LFEC20/LFECP20					LFECP/EC33				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
Y19	NC	-			Y19	PR65A	3	T	RDQS65
AA23	NC	-			AA23	PR64B	3	C	
-	-	-			GND	GND3	3		
AA22	NC	-			AA22	PR64A	3	T	
AB23	NC	-			AB23	PR63B	3	C	
AB24	NC	-			AB24	PR63A	3	T	
Y21	NC	-			Y21	PR62B	3	C	
AA21	NC	-			AA21	PR62A	3	T	
Y23	NC	-			Y23	PR61B	3	C	
Y22	NC	-			Y22	PR61A	3	T	
AA24	NC	-			AA24	PR60B	3	C	
-	-	-			GND	GND3	3		
Y24	NC	-			Y24	PR60A	3	T	
AC25	PR47B	3	C		AC25	PR59B	3	C	
AC26	PR47A	3	T		AC26	PR59A	3	T	
AB25	PR46B	3	C		AB25	PR58B	3	C	
AA25	PR46A	3	T		AA25	PR58A	3	T	
AB26	PR45B	3	C		AB26	PR57B	3	C	
AA26	PR45A	3	T	RDQS45	AA26	PR57A	3	T	RDQS57
W23	PR44B	3	C	RLM0_PLLC_IN_A	W23	PR56B	3	C	RLM0_PLLC_IN_A
GND	GND3	3			GND	GND3	3		
W24	PR44A	3	T	RLM0_PLLT_IN_A	W24	PR56A	3	T	RLM0_PLLT_IN_A
W22	PR43B	3	C	RLM0_PLLC_FB_A	W22	PR55B	3	C	RLM0_PLLC_FB_A
W21	PR43A	3	T	RLM0_PLLT_FB_A	W21	PR55A	3	T	RLM0_PLLT_FB_A
Y25	PR42B	3	C	DI/CSSPIN	Y25	PR54B	3	C	DI/CSSPIN
Y26	PR42A	3	T	DOUT/CSON	Y26	PR54A	3	T	DOUT/CSON
W25	PR41B	3	C	BUSY/SISPI	W25	PR53B	3	C	BUSY/SISPI
W26	PR41A	3	T	D7/SPID0	W26	PR53A	3	T	D7/SPID0
V24	CFG2	3			V24	CFG2	3		
V21	CFG1	3			V21	CFG1	3		
V23	CFG0	3			V23	CFG0	3		
V22	PROGRAMN	3			V22	PROGRAMN	3		
V20	CCLK	3			V20	CCLK	3		
V25	INITN	3			V25	INITN	3		
U20	DONE	3			U20	DONE	3		
V26	PR39B	3	C		V26	PR51B	3	C	
GND	GND3	3			GND	GND3	3		
U26	PR39A	3	T		U26	PR51A	3	T	
U24	PR38B	3	C		U24	PR50B	3	C	
U25	PR38A	3	T		U25	PR50A	3	T	
U23	PR37B	3	C		U23	PR49B	3	C	
U22	PR37A	3	T		U22	PR49A	3	T	

LatticeECP Commercial (Continued)

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFECP33E-3F484C	360	-3	fpBGA	484	COM	32.8K
LFECP33E-4F484C	360	-4	fpBGA	484	COM	32.8K
LFECP33E-5F484C	360	-5	fpBGA	484	COM	32.8K

LatticeEC Industrial

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFEC1E-3Q208I	112	-3	PQFP	208	IND	1.5K
LFEC1E-4Q208I	112	-4	PQFP	208	IND	1.5K
LFEC1E-3T144I	97	-3	TQFP	144	IND	1.5K
LFEC1E-4T144I	97	-4	TQFP	144	IND	1.5K
LFEC1E-3T100I	67	-3	TQFP	100	IND	1.5K
LFEC1E-4T100I	67	-4	TQFP	100	IND	1.5K

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFEC3E-3F256I	160	-3	fpBGA	256	IND	3.1K
LFEC3E-4F256I	160	-4	fpBGA	256	IND	3.1K
LFEC3E-3Q208I	145	-3	PQFP	208	IND	3.1K
LFEC3E-4Q208I	145	-4	PQFP	208	IND	3.1K
LFEC3E-3T144I	97	-3	TQFP	144	IND	3.1K
LFEC3E-4T144I	97	-4	TQFP	144	IND	3.1K
LFEC3E-3T100I	67	-3	TQFP	100	IND	3.1K
LFEC3E-4T100I	67	-4	TQFP	100	IND	3.1K

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFEC6E-3F484I	224	-3	fpBGA	484	IND	6.1K
LFEC6E-4F484I	224	-4	fpBGA	484	IND	6.1K
LFEC6E-3F256I	195	-3	fpBGA	256	IND	6.1K
LFEC6E-4F256I	195	-4	fpBGA	256	IND	6.1K
LFEC6E-3Q208I	147	-3	PQFP	208	IND	6.1K
LFEC6E-4Q208I	147	-4	PQFP	208	IND	6.1K
LFEC6E-3T144I	97	-3	TQFP	144	IND	6.1K
LFEC6E-4T144I	97	-4	TQFP	144	IND	6.1K

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFEC10E-3F484I	288	-3	fpBGA	484	IND	10.2K
LFEC10E-4F484I	288	-4	fpBGA	484	IND	10.2K
LFEC10E-3F256I	195	-3	fpBGA	256	IND	10.2K
LFEC10E-4F256I	195	-4	fpBGA	256	IND	10.2K
LFEC10E-3 P208I	147	-3	PQFP	208	IND	10.2K
LFEC10E-4 P208I	147	-4	PQFP	208	IND	10.2K

Date	Version	Section	Change Summary
December 2004	01.4	Architecture	Updated Hot Socketing Recommended Power Up Sequence section.
		Pinout Information	Added LFEC1, LFEC3, LFECP/EC10, LFECP/EC15 to Pin Information
			Added LFEC1, LFEC3, LFECP/EC10, LFECP/EC15 to Power Supply and NC Connections
			Added LFEC1 and LFEC3 100 TQFP Pinout
			Added LFEC1 and LFEC3 144 TQFP Pinout
			Added LFEC1, LFEC3 and LFECP/EC10 208 PQFP Pinout
			Added LFEC3, LFECP/EC10 and LFECP/EC15 256 fpBGA Pinout
			Added LFECP/EC10 and LFECP/EC15 484 fpBGA Pinout
		Ordering Information	Added Lead-Free Package Designators
			Added Lead-Free Ordering Part Numbers
		Supplemental Information	Updated list of technical notes.
April 2005	01.5	Architecture	EBR memory support section has been updated with clarification.
			Updated sysIO buffer pair section.
		DC & Switching Characteristics	Hot Socketing Specification has been updated.
			DC Electrical Characteristics table (I_{IL}, I_{IH}) has been updated.
			Supply Current (Standby) table has been updated.
			Initialization Supply Current table has been updated.
			External Switching Characteristics section has been updated.
			Removed t_{RSTW} spec. from PLL Parameter table.
			t_{RST} specifications have been updated.
			sysCONFIG Port Timing Specifications (t_{BSCL}, t_{IODISS}, t_{PRGMRJ}) have been updated.
		Pinout Information	Added LFECP/EC33 Pinout Information
			Pin Information Summary table has been updated.
			Power Supply and NC Connection table has been updated.
			484-fpBGA logic connection has been updated (Ball # J6, J17, P6 and P17 for ECP/EC33 are now called VCCPLL).
			672-fpBGA logic connection has been updated (Ball # K19, L8, U19, U8 for ECP/EC33 are now called VCCPLL).
May 2005	01.6	Introduction	ECP/EC33 EBR SRAM Bits and Blocks have been updated to 498K and 54 respectively.
		Architecture	Table 2-10 has been updated (ECP/EC33 EBR SRAM Bits and Blocks have been updated to 498K and 54 respectively.)
			Recommended Power Up Sequence section has been removed.
		DC & Switching Characteristics	Supply Current (Standby) table has been updated.
			Initialization Supply Current table has been updated.
			Vos test condition has been updated to (VOP+VOM)/2.
			Register-to-Register performance table has been updated (rev. G 0.27).
			External switching characteristics have been updated (rev. G 0.27).
			Internal timing parameters have been updated (rev. G 0.27).
			Timing adders have been updated (rev. G 0.27).
			sysCONFIG port timing specifications have been updated.
		Pinout Information	Pin Information Summary table has been updated.
			Power Supply and NC Connection table has been updated.
		Ordering Information	OPN list has been updated.